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### Understanding **Embedded - FPGAs (Field Programmable Gate Array)**

Embedded - FPGAs, or Field Programmable Gate Arrays, are advanced integrated circuits that offer unparalleled flexibility and performance for digital systems. Unlike traditional fixed-function logic devices, FPGAs can be programmed and reprogrammed to execute a wide array of logical operations, enabling customized functionality tailored to specific applications. This reprogrammability allows developers to iterate designs quickly and implement complex functions without the need for custom hardware.

### Applications of Embedded - FPGAs

The versatility of Embedded - FPGAs makes them indispensable in numerous fields. In telecommunications.

#### Details

Product Status	Active
Number of LABs/CLBs	1879
Number of Logic Elements/Cells	24051
Total RAM Bits	958464
Number of I/O	226
Number of Gates	-
Voltage - Supply	1.14V ~ 1.26V
Mounting Type	Surface Mount
Operating Temperature	-40°C ~ 100°C (TJ)
Package / Case	324-LFBGA, CSPBGA
Supplier Device Package	324-CSPBGA (15x15)
Purchase URL	<a href="https://www.e-xfl.com/product-detail/xilinx/xc6slx25-2csg324i">https://www.e-xfl.com/product-detail/xilinx/xc6slx25-2csg324i</a>

## eFUSE Read Endurance

Table 11 lists the minimum guaranteed number of read cycle operations for Device DNA and for the AES eFUSE key. For more information, see [UG380: Spartan-6 FPGA Configuration User Guide](#).

Table 11: eFUSE Read Endurance

Symbol	Description	Speed Grade				Units (Min)
		-3	-3N	-2	-1L	
DNA_CYCLES	Number of DNA_PORT READ operations or JTAG ISC_DNA read command operations. Unaffected by SHIFT operations.	30,000,000				Read Cycles
AES_CYCLES	Number of JTAG FUSE_KEY or FUSE_CNTL read command operations. Unaffected by SHIFT operations.	30,000,000				Read Cycles

## GTP Transceiver Specifications

GTP transceivers are available in the Spartan-6 LXT devices. See [DS160: Spartan-6 Family Overview](#) for more information.

### GTP Transceiver DC Characteristics

Table 12: Absolute Maximum Ratings for GTP Transceivers<sup>(1)</sup>

Symbol	Description	Min	Max	Units
MGTAVCC	Analog supply voltage for the GTP transmitter and receiver circuits relative to GND	-0.5	1.32	V
MGTAVTTTX	Analog supply voltage for the GTP transmitter termination circuit relative to GND	-0.5	1.32	V
MGTAVTTRX	Analog supply voltage for the GTP receiver termination circuit relative to GND	-0.5	1.32	V
MGTAVCCPLL	Analog supply voltage for the GTP transmitter and receiver PLL circuits relative to GND	-0.5	1.32	V
MGTAVTTRCAL	Analog supply voltage for the resistor calibration circuit of the GTP transceiver bank (top or bottom)	-0.5	1.32	V
V <sub>IN</sub>	Receiver (RXP/RXN) and Transmitter (TXP/TXN) absolute input voltage	-0.5	1.32	V
V <sub>MGTREFCLK</sub>	Reference clock absolute input voltage	-0.5	1.32	V

**Notes:**

- Stresses beyond those listed under Absolute Maximum Ratings might cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those listed under Operating Conditions is not implied. Exposure to Absolute Maximum Ratings conditions for extended periods of time might affect device reliability.

Table 13: Recommended Operating Conditions for GTP Transceivers<sup>(1)(2)(3)</sup>

Symbol	Description	Min	Typ	Max	Units
MGTAVCC	Analog supply voltage for the GTP transmitter and receiver circuits relative to GND	1.14	1.20	1.26	V
MGTAVTTTX	Analog supply voltage for the GTP transmitter termination circuit relative to GND	1.14	1.20	1.26	V
MGTAVTTRX	Analog supply voltage for the GTP receiver termination circuit relative to GND	1.14	1.20	1.26	V
MGTAVCCPLL	Analog supply voltage for the GTP transmitter and receiver PLL circuits relative to GND	1.14	1.20	1.26	V
MGTAVTTRCAL	Analog supply voltage for the resistor calibration circuit of the GTP transceiver bank (top or bottom)	1.14	1.20	1.26	V

**Notes:**

- Each voltage listed requires the filter circuit described in [UG386: Spartan-6 FPGA GTP Transceivers User Guide](#).
- Voltages are specified for the temperature range of T<sub>j</sub> = -40°C to +125°C.
- The voltage level of MGTAVCCPLL must not exceed the voltage level of MGTAVCC +10mV. The voltage level of MGTAVCC must not exceed the voltage level of MGTAVCCPLL.

Table 17: GTP Transceiver Clock DC Input Level Specification

Symbol	DC Parameter	Min	Typ	Max	Units
$V_{IDIFF}$	Differential peak-to-peak input voltage	200	800	2000	mV
$R_{IN}$	Differential input resistance	80	100	120	$\Omega$
$C_{EXT}$	Required external AC coupling capacitor	–	100	–	nF

### GTP Transceiver Switching Characteristics

Consult [UG386](#): *Spartan-6 FPGA GTP Transceivers User Guide* for further information.

Table 18: GTP Transceiver Performance

Symbol	Description	Speed Grade				Units
		-3	-3N	-2	-1L	
$F_{GTPMAX}$	Maximum GTP transceiver data rate	3.2	3.2	2.7	N/A	Gb/s
$F_{GTPRANGE1}$	GTP transceiver data rate range when PLL_TXDIVSEL_OUT = 1	1.88 to 3.2	1.88 to 3.2	1.88 to 2.7	N/A	Gb/s
$F_{GTPRANGE2}$	GTP transceiver data rate range when PLL_TXDIVSEL_OUT = 2	0.94 to 1.62	0.94 to 1.62	0.94 to 1.62	N/A	Gb/s
$F_{GTPRANGE3}$	GTP transceiver data rate range when PLL_TXDIVSEL_OUT = 4	0.6 to 0.81	0.6 to 0.81	0.6 to 0.81	N/A	Gb/s
$F_{GPLLMAX}$	Maximum PLL frequency	1.62	1.62	1.62	N/A	GHz
$F_{GPLLMIN}$	Minimum PLL frequency	0.94	0.94	0.94	N/A	GHz

Table 19: GTP Transceiver Dynamic Reconfiguration Port (DRP) Switching Characteristics

Symbol	Description	Speed Grade				Units
		-3	-3N	-2	-1L	
$F_{GTPDRPCLK}$	GTP transceiver DCLK (DRP clock) maximum frequency	125	125	100	N/A	MHz

Table 20: GTP Transceiver Reference Clock Switching Characteristics

Symbol	Description	Conditions	All LXT Speed Grades			Units
			Min	Typ	Max	
$F_{GCLK}$	Reference clock frequency range		60	–	160	MHz
$T_{RCLK}$	Reference clock rise time	20% – 80%	–	200	–	ps
$T_{FCLK}$	Reference clock fall time	80% – 20%	–	200	–	ps
$T_{DCREF}$	Reference clock duty cycle	Transceiver PLL only	45	50	55	%
$T_{LOCK}$	Clock recovery frequency acquisition time	Initial PLL lock	–	–	1	ms
$T_{PHASE}$	Clock recovery phase acquisition time	Lock to data after PLL has locked to the reference clock	–	–	200	$\mu$ s

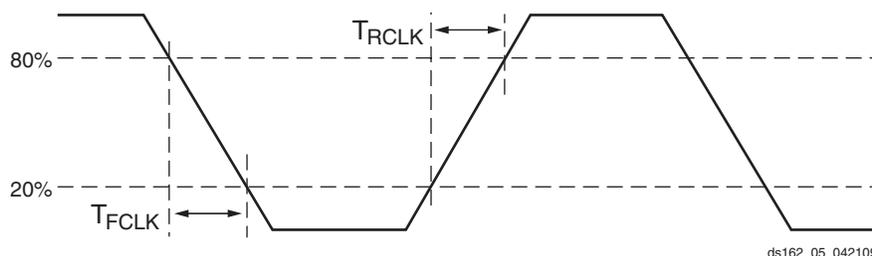


Figure 3: Reference Clock Timing Parameters

Table 21: GTP Transceiver User Clock Switching Characteristics<sup>(1)</sup>

Symbol	Description	Conditions	Speed Grade				Units
			-3	-3N	-2	-1L	
F <sub>TXOUT</sub>	TXOUTCLK maximum frequency		320	320	270	N/A	MHz
F <sub>RXREC</sub>	RXRECCLK maximum frequency		320	320	270	N/A	MHz
T <sub>RX</sub>	RXUSRCLK maximum frequency		320	320	270	N/A	MHz
T <sub>RX2</sub>	RXUSRCLK2 maximum frequency	1 byte interface	156.25	156.25	125	N/A	MHz
		2 byte interface	160	160	125	N/A	MHz
		4 byte interface	80	80	67.5	N/A	MHz
T <sub>TX</sub>	TXUSRCLK maximum frequency		320	320	270	N/A	MHz
T <sub>TX2</sub>	TXUSRCLK2 maximum frequency	1 byte interface	156.25	156.25	125	N/A	MHz
		2 byte interface	160	160	125	N/A	MHz
		4 byte interface	80	80	67.5	N/A	MHz

Notes:

1. Clocking must be implemented as described in [UG386: Spartan-6 FPGA GTP Transceivers User Guide](#).

Table 22: GTP Transceiver Transmitter Switching Characteristics

Symbol	Description	Condition	Min	Typ	Max	Units
T <sub>RTX</sub>	TX Rise time	20%–80%	–	140	–	ps
T <sub>FTX</sub>	TX Fall time	80%–20%	–	120	–	ps
T <sub>LLSKEW</sub>	TX lane-to-lane skew <sup>(1)</sup>		–	–	400	ps
V <sub>TXOOBVDPP</sub>	Electrical idle amplitude		–	–	20	mV
T <sub>TXOOBTRANSITION</sub>	Electrical idle transition time		–	–	50	ns
T <sub>J3.125</sub>	Total Jitter <sup>(2)</sup>	3.125 Gb/s	–	–	0.35	UI
D <sub>J3.125</sub>	Deterministic Jitter <sup>(2)</sup>		–	–	0.15	UI
T <sub>J2.5</sub>	Total Jitter <sup>(2)</sup>	2.5 Gb/s	–	–	0.33	UI
D <sub>J2.5</sub>	Deterministic Jitter <sup>(2)</sup>		–	–	0.15	UI
T <sub>J1.62</sub>	Total Jitter <sup>(2)</sup>	1.62 Gb/s	–	–	0.20	UI
D <sub>J1.62</sub>	Deterministic Jitter <sup>(2)</sup>		–	–	0.10	UI
T <sub>J1.25</sub>	Total Jitter <sup>(2)</sup>	1.25 Gb/s	–	–	0.20	UI
D <sub>J1.25</sub>	Deterministic Jitter <sup>(2)</sup>		–	–	0.10	UI
T <sub>J614</sub>	Total Jitter <sup>(2)</sup>	614 Mb/s	–	–	0.10	UI
D <sub>J614</sub>	Deterministic Jitter <sup>(2)</sup>		–	–	0.05	UI

Notes:

1. Using same REFCLK input with TXENPMAPHASEALIGN enabled for up to four consecutive GTP transceiver sites.
2. Using PLL\_DIVSEL\_FB = 2, INTDATAWIDTH = 1. These values are NOT intended for protocol specific compliance determinations.

Table 27: Spartan-6 Device Production Software and Speed Specification Release<sup>(1)</sup> (Cont'd)

Device	Speed Grade Designations <sup>(2)</sup>			
	-3 <sup>(3)</sup>	-3N	-2 <sup>(4)</sup>	-1L
XQ6SLX75	N/A	N/A	ISE 13.2 v1.19	ISE 13.2 v1.07
XQ6SLX75T	ISE 13.2 v1.19	N/A	ISE 13.2 v1.19	N/A
XQ6SLX150	N/A	N/A	ISE 13.2 v1.19	ISE 13.2 v1.07
XQ6SLX150T	ISE 13.2 v1.19	N/A	ISE 13.2 v1.19	N/A

Notes:

1. ISE 13.3 software with v1.20 for -3, -3N, and -2; and v1.08 for -1L speed specification reflects the changes outlined in [XCN11028: Spartan-6 FPGA Speed File Changes](#).
2. As marked with an N/A, LXT devices and all XA devices are not available with a -1L speed grade; LX4 devices and all XA and XQ devices are not available with a -3N speed grade.
3. Improved -3 specifications reflected in this data sheet require ISE 12.4 software with v1.15 speed specification.
4. Improved -2 specifications reflected in this data sheet require ISE 12.4 software and the *12.4 Speed Files Patch* which contains the v1.17 speed specification available on the [Xilinx Download Center](#).
5. ISE 12.3 software with v1.12 speed specification is available using ISE 12.3 software and the *12.3 Speed Files Patch* available on the [Xilinx Download Center](#).
6. ISE 12.2 software with v1.11 speed specification is available using ISE 12.2 software and the *12.2 Speed Files Patch* available on the [Xilinx Download Center](#).
7. ISE 13.1 software with v1.18 speed specification is available using ISE 13.1 software and the *13.1 Update* available on the [Xilinx Download Center](#). See [XCN11012: Speed File Change for -3N Devices](#).

### IOB Pad Input/Output/3-State Switching Characteristics

Table 28 (for commercial (XC) Spartan-6 devices) and Table 29 (for Automotive XA Spartan-6 and Defense-grade Spartan-6Q devices) summarizes the values of standard-specific data input delays, output delays terminating at pads (based on standard), and 3-state delays.

- $T_{IOPI}$  is described as the delay from IOB pad through the input buffer to the I-pin of an IOB pad. The delay varies depending on the capability of the SelectIO input buffer.
- $T_{IOOP}$  is described as the delay from the O pin to the IOB pad through the output buffer of an IOB pad. The delay varies depending on the capability of the SelectIO output buffer.
- $T_{IOTP}$  is described as the delay from the T pin to the IOB pad through the output buffer of an IOB pad, when 3-state is disabled. The delay varies depending on the SelectIO capability of the output buffer.

See the TRACE report for further information on delays when using an I/O standard with UNTUNED termination on inputs or outputs.

Table 28: IOB Switching Characteristics for the Commercial (XC) Spartan-6 Devices

I/O Standard	$T_{IOPI}$				$T_{IOOP}$				$T_{IOTP}$				Units
	Speed Grade				Speed Grade				Speed Grade				
	-3	-3N	-2	-1L <sup>(1)</sup>	-3	-3N	-2	-1L <sup>(1)</sup>	-3	-3N	-2	-1L <sup>(1)</sup>	
LVDS_33	1.17	1.29	1.42	1.68	1.55	1.69	1.89	2.42	3000	3000	3000	3000	ns
LVDS_25	1.01	1.13	1.26	1.57	1.65	1.79	1.99	2.47	3000	3000	3000	3000	ns
BLVDS_25	1.02	1.14	1.27	1.57	1.72	1.86	2.06	2.68	1.72	1.86	2.06	2.68	ns
MINI_LVDS_33	1.17	1.29	1.42	1.68	1.57	1.71	1.91	2.41	3000	3000	3000	3000	ns
MINI_LVDS_25	1.01	1.13	1.26	1.57	1.65	1.79	1.99	2.47	3000	3000	3000	3000	ns
LVPECL_33	1.18	1.30	1.43	1.68	N/A	N/A	N/A	N/A	N/A	N/A	N/A	N/A	ns
LVPECL_25	1.02	1.14	1.27	1.57	N/A	N/A	N/A	N/A	N/A	N/A	N/A	N/A	ns
RSDS_33 (point to point)	1.17	1.29	1.42	1.68	1.57	1.71	1.91	2.42	3000	3000	3000	3000	ns
RSDS_25 (point to point)	1.01	1.13	1.26	1.56	1.65	1.79	1.99	2.47	3000	3000	3000	3000	ns
TMDS_33	1.21	1.33	1.46	1.71	1.54	1.68	1.88	2.50	3000	3000	3000	3000	ns

**Table 28: IOB Switching Characteristics for the Commercial (XC) Spartan-6 Devices (Cont'd)**

I/O Standard	T <sub>IOPI</sub>				T <sub>IOOP</sub>				T <sub>IOTP</sub>				Units
	Speed Grade				Speed Grade				Speed Grade				
	-3	-3N	-2	-1L <sup>(1)</sup>	-3	-3N	-2	-1L <sup>(1)</sup>	-3	-3N	-2	-1L <sup>(1)</sup>	
LVC MOS33, Fast, 8 mA	1.34	1.46	1.59	1.82	2.07	2.21	2.41	3.03	2.07	2.21	2.41	3.03	ns
LVC MOS33, Fast, 12 mA	1.34	1.46	1.59	1.82	1.65	1.79	1.99	2.62	1.65	1.79	1.99	2.62	ns
LVC MOS33, Fast, 16 mA	1.34	1.46	1.59	1.82	1.65	1.79	1.99	2.62	1.65	1.79	1.99	2.62	ns
LVC MOS33, Fast, 24 mA	1.34	1.46	1.59	1.82	1.65	1.79	1.99	2.62	1.65	1.79	1.99	2.62	ns
LVC MOS25, QUIETIO, 2 mA	0.82	0.94	1.07	1.31	4.81	4.95	5.15	5.79	4.81	4.95	5.15	5.79	ns
LVC MOS25, QUIETIO, 4 mA	0.82	0.94	1.07	1.31	3.70	3.84	4.04	4.66	3.70	3.84	4.04	4.66	ns
LVC MOS25, QUIETIO, 6 mA	0.82	0.94	1.07	1.31	3.46	3.60	3.80	4.38	3.46	3.60	3.80	4.38	ns
LVC MOS25, QUIETIO, 8 mA	0.82	0.94	1.07	1.31	3.20	3.34	3.54	4.12	3.20	3.34	3.54	4.12	ns
LVC MOS25, QUIETIO, 12 mA	0.82	0.94	1.07	1.31	2.83	2.97	3.17	3.75	2.83	2.97	3.17	3.75	ns
LVC MOS25, QUIETIO, 16 mA	0.82	0.94	1.07	1.31	2.64	2.78	2.98	3.64	2.64	2.78	2.98	3.64	ns
LVC MOS25, QUIETIO, 24 mA	0.82	0.94	1.07	1.31	2.45	2.59	2.79	3.42	2.45	2.59	2.79	3.42	ns
LVC MOS25, Slow, 2 mA	0.82	0.94	1.07	1.31	3.78	3.92	4.12	4.76	3.78	3.92	4.12	4.76	ns
LVC MOS25, Slow, 4 mA	0.82	0.94	1.07	1.31	2.79	2.93	3.13	3.73	2.79	2.93	3.13	3.73	ns
LVC MOS25, Slow, 6 mA	0.82	0.94	1.07	1.31	2.73	2.87	3.07	3.66	2.73	2.87	3.07	3.66	ns
LVC MOS25, Slow, 8 mA	0.82	0.94	1.07	1.31	2.48	2.62	2.82	3.42	2.48	2.62	2.82	3.42	ns
LVC MOS25, Slow, 12 mA	0.82	0.94	1.07	1.31	2.01	2.15	2.35	2.95	2.01	2.15	2.35	2.95	ns
LVC MOS25, Slow, 16 mA	0.82	0.94	1.07	1.31	2.01	2.15	2.35	2.95	2.01	2.15	2.35	2.95	ns
LVC MOS25, Slow, 24 mA	0.82	0.94	1.07	1.31	2.01	2.15	2.35	2.94	2.01	2.15	2.35	2.94	ns
LVC MOS25, Fast, 2 mA	0.82	0.94	1.07	1.31	3.35	3.49	3.69	4.31	3.35	3.49	3.69	4.31	ns
LVC MOS25, Fast, 4 mA	0.82	0.94	1.07	1.31	2.25	2.39	2.59	3.22	2.25	2.39	2.59	3.22	ns
LVC MOS25, Fast, 6 mA	0.82	0.94	1.07	1.31	2.09	2.23	2.43	3.05	2.09	2.23	2.43	3.05	ns
LVC MOS25, Fast, 8 mA	0.82	0.94	1.07	1.31	2.02	2.16	2.36	2.98	2.02	2.16	2.36	2.98	ns
LVC MOS25, Fast, 12 mA	0.82	0.94	1.07	1.31	1.56	1.70	1.90	2.52	1.56	1.70	1.90	2.52	ns
LVC MOS25, Fast, 16 mA	0.82	0.94	1.07	1.31	1.56	1.70	1.90	2.52	1.56	1.70	1.90	2.52	ns
LVC MOS25, Fast, 24 mA	0.82	0.94	1.07	1.31	1.56	1.70	1.90	2.52	1.56	1.70	1.90	2.52	ns
LVC MOS18, QUIETIO, 2 mA	1.18	1.30	1.43	2.04	5.92	6.06	6.26	6.80	5.92	6.06	6.26	6.80	ns
LVC MOS18, QUIETIO, 4 mA	1.18	1.30	1.43	2.04	4.74	4.88	5.08	5.63	4.74	4.88	5.08	5.63	ns
LVC MOS18, QUIETIO, 6 mA	1.18	1.30	1.43	2.04	4.05	4.19	4.39	4.96	4.05	4.19	4.39	4.96	ns
LVC MOS18, QUIETIO, 8 mA	1.18	1.30	1.43	2.04	3.71	3.85	4.05	4.63	3.71	3.85	4.05	4.63	ns
LVC MOS18, QUIETIO, 12 mA	1.18	1.30	1.43	2.04	3.35	3.49	3.69	4.27	3.35	3.49	3.69	4.27	ns
LVC MOS18, QUIETIO, 16 mA	1.18	1.30	1.43	2.04	3.20	3.34	3.54	4.14	3.20	3.34	3.54	4.14	ns
LVC MOS18, QUIETIO, 24 mA	1.18	1.30	1.43	2.04	2.96	3.10	3.30	3.98	2.96	3.10	3.30	3.98	ns
LVC MOS18, Slow, 2 mA	1.18	1.30	1.43	2.04	4.62	4.76	4.96	5.54	4.62	4.76	4.96	5.54	ns
LVC MOS18, Slow, 4 mA	1.18	1.30	1.43	2.04	3.69	3.83	4.03	4.60	3.69	3.83	4.03	4.60	ns
LVC MOS18, Slow, 6 mA	1.18	1.30	1.43	2.04	3.00	3.14	3.34	3.94	3.00	3.14	3.34	3.94	ns
LVC MOS18, Slow, 8 mA	1.18	1.30	1.43	2.04	2.19	2.33	2.53	3.17	2.19	2.33	2.53	3.17	ns
LVC MOS18, Slow, 12 mA	1.18	1.30	1.43	2.04	1.99	2.13	2.33	2.95	1.99	2.13	2.33	2.95	ns
LVC MOS18, Slow, 16 mA	1.18	1.30	1.43	2.04	1.99	2.13	2.33	2.95	1.99	2.13	2.33	2.95	ns

Table 28: IOB Switching Characteristics for the Commercial (XC) Spartan-6 Devices (Cont'd)

I/O Standard	T <sub>IOPI</sub>				T <sub>IOOP</sub>				T <sub>IOTP</sub>				Units
	Speed Grade				Speed Grade				Speed Grade				
	-3	-3N	-2	-1L <sup>(1)</sup>	-3	-3N	-2	-1L <sup>(1)</sup>	-3	-3N	-2	-1L <sup>(1)</sup>	
LVC MOS18, Slow, 24 mA	1.18	1.30	1.43	2.04	1.99	2.13	2.33	2.95	1.99	2.13	2.33	2.95	ns
LVC MOS18, Fast, 2 mA	1.18	1.30	1.43	2.04	3.59	3.73	3.93	4.53	3.59	3.73	3.93	4.53	ns
LVC MOS18, Fast, 4 mA	1.18	1.30	1.43	2.04	2.39	2.53	2.73	3.35	2.39	2.53	2.73	3.35	ns
LVC MOS18, Fast, 6 mA	1.18	1.30	1.43	2.04	1.88	2.02	2.22	2.84	1.88	2.02	2.22	2.84	ns
LVC MOS18, Fast, 8 mA	1.18	1.30	1.43	2.04	1.81	1.95	2.15	2.77	1.81	1.95	2.15	2.77	ns
LVC MOS18, Fast, 12 mA	1.18	1.30	1.43	2.04	1.71	1.85	2.05	2.67	1.71	1.85	2.05	2.67	ns
LVC MOS18, Fast, 16 mA	1.18	1.30	1.43	2.04	1.71	1.85	2.05	2.67	1.71	1.85	2.05	2.67	ns
LVC MOS18, Fast, 24 mA	1.18	1.30	1.43	2.04	1.71	1.85	2.05	2.67	1.71	1.85	2.05	2.67	ns
LVC MOS18_JEDEC, QUIETIO, 2 mA	0.94	1.06	1.19	1.41	5.91	6.05	6.25	6.79	5.91	6.05	6.25	6.79	ns
LVC MOS18_JEDEC, QUIETIO, 4 mA	0.94	1.06	1.19	1.41	4.75	4.89	5.09	5.64	4.75	4.89	5.09	5.64	ns
LVC MOS18_JEDEC, QUIETIO, 6 mA	0.94	1.06	1.19	1.41	4.04	4.18	4.38	4.96	4.04	4.18	4.38	4.96	ns
LVC MOS18_JEDEC, QUIETIO, 8 mA	0.94	1.06	1.19	1.41	3.71	3.85	4.05	4.62	3.71	3.85	4.05	4.62	ns
LVC MOS18_JEDEC, QUIETIO, 12 mA	0.94	1.06	1.19	1.41	3.35	3.49	3.69	4.28	3.35	3.49	3.69	4.28	ns
LVC MOS18_JEDEC, QUIETIO, 16 mA	0.94	1.06	1.19	1.41	3.20	3.34	3.54	4.13	3.20	3.34	3.54	4.13	ns
LVC MOS18_JEDEC, QUIETIO, 24 mA	0.94	1.06	1.19	1.41	2.96	3.10	3.30	3.98	2.96	3.10	3.30	3.98	ns
LVC MOS18_JEDEC, Slow, 2 mA	0.94	1.06	1.19	1.41	4.59	4.73	4.93	5.54	4.59	4.73	4.93	5.54	ns
LVC MOS18_JEDEC, Slow, 4 mA	0.94	1.06	1.19	1.41	3.69	3.83	4.03	4.60	3.69	3.83	4.03	4.60	ns
LVC MOS18_JEDEC, Slow, 6 mA	0.94	1.06	1.19	1.41	3.00	3.14	3.34	3.94	3.00	3.14	3.34	3.94	ns
LVC MOS18_JEDEC, Slow, 8 mA	0.94	1.06	1.19	1.41	2.19	2.33	2.53	3.18	2.19	2.33	2.53	3.18	ns
LVC MOS18_JEDEC, Slow, 12 mA	0.94	1.06	1.19	1.41	1.99	2.13	2.33	2.95	1.99	2.13	2.33	2.95	ns
LVC MOS18_JEDEC, Slow, 16 mA	0.94	1.06	1.19	1.41	1.99	2.13	2.33	2.95	1.99	2.13	2.33	2.95	ns
LVC MOS18_JEDEC, Slow, 24 mA	0.94	1.06	1.19	1.41	1.99	2.13	2.33	2.95	1.99	2.13	2.33	2.95	ns
LVC MOS18_JEDEC, Fast, 2 mA	0.94	1.06	1.19	1.41	3.57	3.71	3.91	4.52	3.57	3.71	3.91	4.52	ns
LVC MOS18_JEDEC, Fast, 4 mA	0.94	1.06	1.19	1.41	2.39	2.53	2.73	3.35	2.39	2.53	2.73	3.35	ns
LVC MOS18_JEDEC, Fast, 6 mA	0.94	1.06	1.19	1.41	1.88	2.02	2.22	2.84	1.88	2.02	2.22	2.84	ns
LVC MOS18_JEDEC, Fast, 8 mA	0.94	1.06	1.19	1.41	1.80	1.94	2.14	2.76	1.80	1.94	2.14	2.76	ns
LVC MOS18_JEDEC, Fast, 12 mA	0.94	1.06	1.19	1.41	1.72	1.86	2.06	2.68	1.72	1.86	2.06	2.68	ns
LVC MOS18_JEDEC, Fast, 16 mA	0.94	1.06	1.19	1.41	1.72	1.86	2.06	2.68	1.72	1.86	2.06	2.68	ns
LVC MOS18_JEDEC, Fast, 24 mA	0.94	1.06	1.19	1.41	1.72	1.86	2.06	2.68	1.72	1.86	2.06	2.68	ns
LVC MOS15, QUIETIO, 2 mA	0.98	1.10	1.23	1.79	5.47	5.61	5.81	6.38	5.47	5.61	5.81	6.38	ns
LVC MOS15, QUIETIO, 4 mA	0.98	1.10	1.23	1.79	4.61	4.75	4.95	5.51	4.61	4.75	4.95	5.51	ns
LVC MOS15, QUIETIO, 6 mA	0.98	1.10	1.23	1.79	4.07	4.21	4.41	4.97	4.07	4.21	4.41	4.97	ns
LVC MOS15, QUIETIO, 8 mA	0.98	1.10	1.23	1.79	3.91	4.05	4.25	4.81	3.91	4.05	4.25	4.81	ns
LVC MOS15, QUIETIO, 12 mA	0.98	1.10	1.23	1.79	3.53	3.67	3.87	4.51	3.53	3.67	3.87	4.51	ns
LVC MOS15, QUIETIO, 16 mA	0.98	1.10	1.23	1.79	3.32	3.46	3.66	4.31	3.32	3.46	3.66	4.31	ns
LVC MOS15, Slow, 2 mA	0.98	1.10	1.23	1.79	4.18	4.32	4.52	5.11	4.18	4.32	4.52	5.11	ns
LVC MOS15, Slow, 4 mA	0.98	1.10	1.23	1.79	3.42	3.56	3.76	4.34	3.42	3.56	3.76	4.34	ns
LVC MOS15, Slow, 6 mA	0.98	1.10	1.23	1.79	2.29	2.43	2.63	3.24	2.29	2.43	2.63	3.24	ns

Table 28: IOB Switching Characteristics for the Commercial (XC) Spartan-6 Devices (Cont'd)

I/O Standard	T <sub>IOPI</sub>				T <sub>IOOP</sub>				T <sub>IOTP</sub>				Units
	Speed Grade				Speed Grade				Speed Grade				
	-3	-3N	-2	-1L <sup>(1)</sup>	-3	-3N	-2	-1L <sup>(1)</sup>	-3	-3N	-2	-1L <sup>(1)</sup>	
LVC MOS12, Fast, 2 mA	0.91	1.03	1.16	1.51	3.46	3.60	3.80	4.44	3.46	3.60	3.80	4.44	ns
LVC MOS12, Fast, 4 mA	0.91	1.03	1.16	1.51	2.35	2.49	2.69	3.30	2.35	2.49	2.69	3.30	ns
LVC MOS12, Fast, 6 mA	0.91	1.03	1.16	1.51	1.79	1.93	2.13	2.75	1.79	1.93	2.13	2.75	ns
LVC MOS12, Fast, 8 mA	0.91	1.03	1.16	1.51	1.68	1.82	2.02	2.64	1.68	1.82	2.02	2.64	ns
LVC MOS12, Fast, 12 mA	0.91	1.03	1.16	1.51	1.66	1.80	2.00	2.62	1.66	1.80	2.00	2.62	ns
LVC MOS12_JEDEC, QUIETIO, 2 mA	1.50	1.62	1.75	1.88	6.39	6.53	6.73	7.31	6.39	6.53	6.73	7.31	ns
LVC MOS12_JEDEC, QUIETIO, 4 mA	1.50	1.62	1.75	1.88	4.98	5.12	5.32	5.88	4.98	5.12	5.32	5.88	ns
LVC MOS12_JEDEC, QUIETIO, 6 mA	1.50	1.62	1.75	1.88	4.67	4.81	5.01	5.54	4.67	4.81	5.01	5.54	ns
LVC MOS12_JEDEC, QUIETIO, 8 mA	1.50	1.62	1.75	1.88	4.23	4.37	4.57	5.22	4.23	4.37	4.57	5.22	ns
LVC MOS12_JEDEC, QUIETIO, 12 mA	1.50	1.62	1.75	1.88	3.99	4.13	4.33	4.94	3.99	4.13	4.33	4.94	ns
LVC MOS12_JEDEC, Slow, 2 mA	1.50	1.62	1.75	1.88	5.00	5.14	5.34	5.90	5.00	5.14	5.34	5.90	ns
LVC MOS12_JEDEC, Slow, 4 mA	1.50	1.62	1.75	1.88	2.85	2.99	3.19	3.80	2.85	2.99	3.19	3.80	ns
LVC MOS12_JEDEC, Slow, 6 mA	1.50	1.62	1.75	1.88	2.76	2.90	3.10	3.72	2.76	2.90	3.10	3.72	ns
LVC MOS12_JEDEC, Slow, 8 mA	1.50	1.62	1.75	1.88	2.35	2.49	2.69	3.30	2.35	2.49	2.69	3.30	ns
LVC MOS12_JEDEC, Slow, 12 mA	1.50	1.62	1.75	1.88	2.09	2.23	2.43	3.05	2.09	2.23	2.43	3.05	ns
LVC MOS12_JEDEC, Fast, 2 mA	1.50	1.62	1.75	1.88	3.46	3.60	3.80	4.42	3.46	3.60	3.80	4.42	ns
LVC MOS12_JEDEC, Fast, 4 mA	1.50	1.62	1.75	1.88	2.35	2.49	2.69	3.31	2.35	2.49	2.69	3.31	ns
LVC MOS12_JEDEC, Fast, 6 mA	1.50	1.62	1.75	1.88	1.79	1.93	2.13	2.76	1.79	1.93	2.13	2.76	ns
LVC MOS12_JEDEC, Fast, 8 mA	1.50	1.62	1.75	1.88	1.69	1.83	2.03	2.65	1.69	1.83	2.03	2.65	ns
LVC MOS12_JEDEC, Fast, 12 mA	1.50	1.62	1.75	1.88	1.66	1.80	2.00	2.62	1.66	1.80	2.00	2.62	ns

**Notes:**

1. The -1L values listed in this table are also applicable to the Spartan-6Q devices.
2. Devices with a -1L speed grade do not support Xilinx PCI IP.

Table 29: IOB Switching Characteristics for the Automotive XA Spartan-6 and the Spartan-6Q Devices<sup>(1)</sup> (Cont'd)

I/O Standard	T <sub>IOPI</sub>		T <sub>IOOP</sub>		T <sub>IOTP</sub>		Units
	Speed Grade		Speed Grade		Speed Grade		
	-3	-2	-3	-2	-3	-2	
LVC MOS33, Slow, 6 mA	1.41	1.59	2.79	2.99	2.79	2.99	ns
LVC MOS33, Slow, 8 mA	1.41	1.59	2.79	2.99	2.79	2.99	ns
LVC MOS33, Slow, 12 mA	1.41	1.59	2.53	2.73	2.53	2.73	ns
LVC MOS33, Slow, 16 mA	1.41	1.59	2.45	2.65	2.45	2.65	ns
LVC MOS33, Slow, 24 mA	1.41	1.59	2.42	2.62	2.42	2.62	ns
LVC MOS33, Fast, 2 mA	1.41	1.59	4.05	4.25	4.05	4.25	ns
LVC MOS33, Fast, 4 mA	1.41	1.59	2.66	2.86	2.66	2.86	ns
LVC MOS33, Fast, 6 mA	1.41	1.59	2.46	2.66	2.46	2.66	ns
LVC MOS33, Fast, 8 mA	1.41	1.59	2.21	2.41	2.21	2.41	ns
LVC MOS33, Fast, 12 mA	1.41	1.59	1.80	2.00	1.80	2.00	ns
LVC MOS33, Fast, 16 mA	1.41	1.59	1.80	2.00	1.80	2.00	ns
LVC MOS33, Fast, 24 mA	1.41	1.59	1.80	2.00	1.80	2.00	ns
LVC MOS25, QUIETIO, 2 mA	0.89	1.07	5.00	5.20	5.00	5.20	ns
LVC MOS25, QUIETIO, 4 mA	0.89	1.07	3.85	4.05	3.85	4.05	ns
LVC MOS25, QUIETIO, 6 mA	0.89	1.07	3.60	3.80	3.60	3.80	ns
LVC MOS25, QUIETIO, 8 mA	0.89	1.07	3.34	3.54	3.34	3.54	ns
LVC MOS25, QUIETIO, 12 mA	0.89	1.07	2.98	3.18	2.98	3.18	ns
LVC MOS25, QUIETIO, 16 mA	0.89	1.07	2.79	2.99	2.79	2.99	ns
LVC MOS25, QUIETIO, 24 mA	0.89	1.07	2.64	2.84	2.64	2.84	ns
LVC MOS25, Slow, 2 mA	0.89	1.07	3.96	4.16	3.96	4.16	ns
LVC MOS25, Slow, 4 mA	0.89	1.07	2.96	3.16	2.96	3.16	ns
LVC MOS25, Slow, 6 mA	0.89	1.07	2.88	3.08	2.88	3.08	ns
LVC MOS25, Slow, 8 mA	0.89	1.07	2.63	2.83	2.63	2.83	ns
LVC MOS25, Slow, 12 mA	0.89	1.07	2.15	2.35	2.15	2.35	ns
LVC MOS25, Slow, 16 mA	0.89	1.07	2.15	2.35	2.15	2.35	ns
LVC MOS25, Slow, 24 mA	0.89	1.07	2.15	2.35	2.15	2.35	ns
LVC MOS25, Fast, 2 mA	0.89	1.07	3.52	3.72	3.52	3.72	ns
LVC MOS25, Fast, 4 mA	0.89	1.07	2.43	2.63	2.43	2.63	ns
LVC MOS25, Fast, 6 mA	0.89	1.07	2.23	2.43	2.23	2.43	ns
LVC MOS25, Fast, 8 mA	0.89	1.07	2.16	2.36	2.16	2.36	ns
LVC MOS25, Fast, 12 mA	0.89	1.07	1.70	1.90	1.70	1.90	ns
LVC MOS25, Fast, 16 mA	0.89	1.07	1.70	1.90	1.70	1.90	ns
LVC MOS25, Fast, 24 mA	0.89	1.07	1.70	1.90	1.70	1.90	ns
LVC MOS18, QUIETIO, 2 mA	1.25	1.43	6.11	6.31	6.11	6.31	ns
LVC MOS18, QUIETIO, 4 mA	1.25	1.43	4.88	5.08	4.88	5.08	ns
LVC MOS18, QUIETIO, 6 mA	1.25	1.43	4.20	4.40	4.20	4.40	ns
LVC MOS18, QUIETIO, 8 mA	1.25	1.43	3.86	4.06	3.86	4.06	ns
LVC MOS18, QUIETIO, 12 mA	1.25	1.43	3.49	3.69	3.49	3.69	ns

Table 34: SSO Limit per V<sub>CCO</sub>/GND Pair

V <sub>CCO</sub>	I/O Standard	Drive	Slew	SSO Limit per V <sub>CCO</sub> /GND Pair			
				All TQG144, CPG196, CSG225, FT(G)256, and LX devices in CSG324		All CS(G)484, FG(G)484, FG(G)676, FG(G)900, and LXT devices in CSG324	
				Bank 0/2	Bank 1/3	Bank 0/2	Bank 1/3/4/5
1.2V	LVCMOS12, LVCMOS12_JEDEC	2	Fast	30 (1)	35	30	35
			Slow	51	55	51	52
			QuietIO	71	58	71	70
		4	Fast	17	17	17	19
			Slow	23	25	23	22
			QuietIO	35	32	35	32
		6	Fast	13	15	13	14
			Slow	19	20	19	17
			QuietIO	26	24	26	24
		8	Fast	N/A	12	N/A	12
			Slow	N/A	15	N/A	13
			QuietIO	N/A	20	N/A	19
		12	Fast	N/A	5	N/A	4
			Slow	N/A	8	N/A	5
			QuietIO	N/A	11	N/A	10

Table 34: SSO Limit per V<sub>CCO</sub>/GND Pair (Cont'd)

V <sub>CCO</sub>	I/O Standard	Drive	Slew	SSO Limit per V <sub>CCO</sub> /GND Pair					
				All TQG144, CPG196, CSG225, FT(G)256, and LX devices in CSG324		All CS(G)484, FG(G)484, FG(G)676, FG(G)900, and LXT devices in CSG324			
				Bank 0/2	Bank 1/3	Bank 0/2	Bank 1/3/4/5		
1.8V	LVCMOS18, LVCMOS18_JEDEC	2	Fast	39	46	39	47		
			Slow	65	75	65	74		
			QuietIO	80	80	80	85		
		4	Fast	22	25	22	25		
			Slow	38	36	38	29		
			QuietIO	45	40	45	35		
		6	Fast	16	18	16	17		
			Slow	27	25	27	19		
			QuietIO	30	28	30	23		
		8	Fast	13	15	13	14		
			Slow	16	18	16	16		
			QuietIO	25	22	25	18		
		12	Fast	5	7	5	5		
			Slow	7	8	7	6		
			QuietIO	11	10	11	8		
		16	Fast	4	5	4	4		
			Slow	7	8	7	5		
			QuietIO	11	10	11	8		
		24	Fast	N/A	5	N/A	3		
			Slow	N/A	8	N/A	8		
			QuietIO	N/A	10	N/A	8		
		HSTL_I_18				9	10	9	9
		HSTL_II_18				N/A	5	N/A	6
		HSTL_III_18				9	10	9	11
		DIFF_HSTL_I_18				27	30	27	27
		DIFF_HSTL_II_18				N/A	15	N/A	18
		DIFF_HSTL_III_18				27	30	27	33
MOBILE_DDR <sup>(3)</sup>				12	14	12	14		
DIFF_MOBILE_DDR <sup>(3)</sup>				36	42	36	42		
SSTL_18_I <sup>(3)</sup>				9	10	9	10		
SSTL_18_II <sup>(3)</sup>				N/A	5	N/A	4		
DIFF_SSTL_18_I <sup>(3)</sup>				27	30	27	30		
DIFF_SSTL_18_II <sup>(3)</sup>				N/A	15	N/A	12		

Table 34: SSO Limit per V<sub>CCO</sub>/GND Pair (Cont'd)

V <sub>CCO</sub>	I/O Standard	Drive	Slew	SSO Limit per V <sub>CCO</sub> /GND Pair			
				All TQG144, CPG196, CSG225, FT(G)256, and LX devices in CSG324		All CS(G)484, FG(G)484, FG(G)676, FG(G)900, and LXT devices in CSG324	
				Bank 0/2	Bank 1/3	Bank 0/2	Bank 1/3/4/5
2.5V	LVCMOS25	2	Fast	38	43	38	43
			Slow	46	52	46	48
			QuietIO	57	64	57	59
		4	Fast	21	24	21	23
			Slow	26	31	26	27
			QuietIO	33	32	33	30
		6	Fast	15	17	15	16
			Slow	19	22	19	19
			QuietIO	25	23	25	19
		8	Fast	12	15	12	14
			Slow	15	18	15	16
			QuietIO	21	19	21	16
		12	Fast	1	3	1	1
			Slow	2	7	2	4
			QuietIO	3	8	3	8
		16	Fast	1	3	1	1
			Slow	3	7	3	3
			QuietIO	4	9	4	8
		24	Fast	N/A	3	N/A	1
			Slow	N/A	5	N/A	2
QuietIO	N/A		8	N/A	6		
SSTL_2_I <sup>(3)</sup>				10	11	10	11
SSTL_2_II <sup>(3)</sup>				N/A	7	N/A	7
DIFF_SSTL_2_I <sup>(3)</sup>				30	33	30	33
DIFF_SSTL_2_II <sup>(3)</sup>				N/A	21	N/A	24

## Block RAM Switching Characteristics

Table 43: Block RAM Switching Characteristics

Symbol	Description	Speed Grade				Units
		-3	-3N	-2	-1L	
<b>Block RAM Clock to Out Delays</b>						
$T_{RCKO\_DO}$	Clock CLK to DOUT output (without output register) <sup>(1)</sup>	1.85	2.10	2.10	3.50	ns, Max
$T_{RCKO\_DO\_REG}$	Clock CLK to DOUT output (with output register) <sup>(2)</sup>	1.60	1.75	1.75	2.30	ns, Max
<b>Setup and Hold Times Before/After Clock CLK</b>						
$T_{RCKC\_ADDR}/T_{RCKC\_ADDR}$	ADDR inputs for XC devices <sup>(3)</sup>	0.35/ 0.10	0.40/ 0.12	0.40/ 0.12	0.50/ 0.15	ns, Min
	ADDR inputs for XA and XQ devices <sup>(3)</sup>	0.35/ 0.17	N/A	0.40/ 0.17	0.50/ 0.15	ns, Min
$T_{RDCK\_DI}/T_{RCKD\_DI}$	DIN inputs <sup>(4)</sup>	0.30/ 0.10	0.30/ 0.10	0.30/ 0.10	0.40/ 0.15	ns, Min
$T_{RCKC\_EN}/T_{RCKC\_EN}$	Block RAM Enable (EN) input	0.22/ 0.05	0.25/ 0.06	0.25/ 0.06	0.44/ 0.10	ns, Min
$T_{RCKC\_REGCE}/T_{RCKC\_REGCE}$	CE input of output register	0.20/ 0.10	0.20/ 0.10	0.20/ 0.10	0.28/ 0.15	ns, Min
$T_{RCKC\_WE}/T_{RCKC\_WE}$	Write Enable (WE) input	0.25/ 0.10	0.33/ 0.10	0.33/ 0.10	0.28/ 0.15	ns, Min
<b>Maximum Frequency</b>						
$F_{MAX}$	Block RAM in all modes	320	280	280	150	MHz

**Notes:**

- $T_{RCKO\_DO}$  includes  $T_{RCKO\_DOA}$  and  $T_{RCKO\_DOPA}$  as well as the B port equivalent timing parameters.
- $T_{RCKO\_DO\_REG}$  includes  $T_{RCKO\_DOA\_REG}$  and  $T_{RCKO\_DOPA\_REG}$  as well as the B port equivalent timing parameters.
- The ADDR setup and hold must be met when EN is asserted (even when WE is deasserted). Otherwise, block RAM data corruption is possible.
- $T_{RDCK\_DI}$  includes both A and B inputs as well as the parity inputs of A and B.

## Configuration Switching Characteristics

Table 47: Configuration Switching Characteristics<sup>(1)</sup>

Symbol	Description	Speed Grade				Units
		-3	-3N	-2	-1L	
<b>Power-up Timing Characteristics</b>						
T <sub>PL</sub> <sup>(2)</sup>	PROGRAM_B Latency	4	4	4	5	ms, Max
T <sub>POR</sub> <sup>(2)</sup>	Power-on reset (50 ms ramp time) <sup>(3)</sup>	5/30	5/34	5/40	5/40	ms, Min/Max
	Power-on reset (10 ms ramp time)	5/25	5/29	5/35	5/40	ms, Min/Max
T <sub>PROGRAM</sub>	PROGRAM_B Pulse Width	500	500	500	500	ns, Min
<b>Slave Serial Mode Programming Switching</b>						
T <sub>DCCK</sub> /T <sub>CCKD</sub>	DIN Setup/Hold, slave mode	6.0/1.0	6.0/1.0	6.0/1.0	8.0/2.0	ns, Min
T <sub>CCO</sub>	CCLK to DOUT	12	12	12	17	ns, Max
F <sub>SCCK</sub>	Slave mode external CCLK	80	80	80	50	MHz, Max
<b>Slave SelectMAP Mode Programming Switching</b>						
T <sub>SMDCCK</sub> /T <sub>SMCCKD</sub>	SelectMAP Data Setup/Hold	6.0/1.0	6.0/1.0	6.0/1.0	8.0/2.0	ns, Min
T <sub>SMCSCCK</sub> /T <sub>SMCCKCS</sub>	CSI_B Setup/Hold	7.0/0.0	7.0/0.0	7.0/0.0	9.0/2.0	ns, Min
T <sub>SMWCCK</sub> /T <sub>SMCCKW</sub>	RDWR_B Setup/Hold	17.0/1.0	17.0/1.0	17.0/1.0	27.0/2.0	ns, Min
T <sub>SMCKCSO</sub>	CSO_B clock to out	16	16	16	26	ns, Max
T <sub>SMCO</sub>	CCLK to DATA out in readback	13	13	13	25	ns, Max
T <sub>SMCKBY</sub>	CCLK to BUSY out in readback	12	12	12	17	ns, Max
F <sub>SMCCK</sub>	Maximum CCLK frequency (LX4, LX9, LX16, LX25, LX25T, LX45, LX45T, LX75, and LX75T only)	50	50	50	25	MHz, Max
	Maximum CCLK frequency (LX100 and LX100T in x8 mode, LX150, and LX150T only)	40	40	40	20	MHz, Max
	Maximum CCLK frequency (LX100 and LX100T in x16 mode only)	35	35	35	20	MHz, Max
F <sub>RBCK</sub>	Maximum Readback CCLK frequency, including block RAM (LX4, LX9, LX16, LX25, LX25T, LX45, LX45T, LX75, and LX75T only)	20	20	20	4	MHz, Max
	Maximum Readback CCLK frequency, ignoring block RAM (POST_CRC) (LX4, LX9, LX16, LX25, LX25T, LX45, LX45T, LX75, and LX75T only)	50	50	50	30	MHz, Max
	Maximum Readback CCLK frequency, including block RAM (LX100, LX100T, LX150, and LX150T only)	12	12	12	4	MHz, Max
	Maximum Readback CCLK frequency, ignoring block RAM (POST_CRC) (LX100, LX100T, LX150, and LX150T only)	35	35	35	20	MHz, Max
<b>Boundary-Scan Port Timing Specifications</b>						
T <sub>TAPTCK</sub>	TMS and TDI Setup time before TCK	10	10	10	17	ns, Min
T <sub>TCKTAP</sub>	TMS and TDI Hold time after TCK	5.5	5.5	5.5	5.5	ns, Min
T <sub>TCKTDO</sub>	TCK falling edge to TDO output valid	6.5	6.5	6.5	8	ns, Max
T <sub>TCKH</sub>	TCK clock minimum High time	12	12	12	21	ns, Min
T <sub>TCKL</sub>	TCK clock minimum Low time	12	12	12	21	ns, Min
F <sub>TCK</sub>	Maximum configuration TCK clock frequency	33	33	33	18	MHz, Max
F <sub>TCKB</sub>	Maximum boundary-scan TCK clock frequency	33	33	33	18	MHz, Max
F <sub>TCKAES</sub>	Maximum AES key TCK clock frequency	2	2	2	2	MHz, Max

Table 56: Switching Characteristics for the Digital Frequency Synthesizer (DFS) for DCM\_SP<sup>(1)</sup>

Symbol	Description	Speed Grade								Units
		-3		-3N		-2		-1L		
		Min	Max	Min	Max	Min	Max	Min	Max	
<b>Output Frequency Ranges</b>										
CLKOUT_FREQ_FX	Frequency for the CLKFX and CLKFX180 outputs	5	375	5	375	5	333	5	200	MHz
<b>Output Clock Jitter<sup>(2)(3)</sup></b>										
CLKOUT_PER_JITT_FX	Period jitter at the CLKFX and CLKFX180 outputs. When CLKIN < 20 MHz	Use the Clocking Wizard								ps
	Period jitter at the CLKFX and CLKFX180 outputs. When CLKIN > 20 MHz	Typical = ±(1% of CLKFX period + 100)								ps
<b>Duty Cycle<sup>(4)(5)</sup></b>										
CLKOUT_DUTY_CYCLE_FX	Duty cycle precision for the CLKFX and CLKFX180 outputs including the BUFGMUX and clock tree duty-cycle distortion	Maximum = ±(1% of CLKFX period + 350)								ps
<b>Phase Alignment<sup>(5)</sup></b>										
CLKOUT_PHASE_FX	Phase offset between the DFS CLKFX output and the DLL CLK0 output when both the DFS and DLL are used	-	±200	-	±200	-	±200	-	±250	ps
CLKOUT_PHASE_FX180	Phase offset between the DFS CLKFX180 output and the DLL CLK0 output when both the DFS and DLL are used	Maximum = ±(1% of CLKFX period + 200)								ps
<b>LOCKED Time</b>										
LOCK_FX <sup>(2)</sup>	When FCLKIN < 50 MHz, the time from deassertion at the DCM's reset input to the rising transition at its LOCKED output. The DFS asserts LOCKED when the CLKFX and CLKFX180 signals are valid. When using both the DLL and the DFS, use the longer locking time.	-	5	-	5	-	5	-	5	ms
	When FCLKIN > 50 MHz, the time from deassertion at the DCM's reset input to the rising transition at its LOCKED output. The DFS asserts LOCKED when the CLKFX and CLKFX180 signals are valid. When using both the DLL and the DFS, use the longer locking time.	-	0.45	-	0.45	-	0.45	-	0.60	ms

**Notes:**

1. The values in this table are based on the operating conditions described in Table 2 and Table 55.
2. For optimal jitter tolerance and a faster LOCK time, use the CLKIN\_PERIOD attribute.
3. Output jitter is characterized with no input jitter. Output jitter strongly depends on the environment, including the number of SSOs, the output drive strength, CLB utilization, CLB switching activities, switching frequency, power supply, and PCB design. The actual maximum output jitter depends on the system application.
4. The CLKFX, CLKFXDV, and CLKFX180 outputs have a duty cycle of approximately 50%.
5. Some duty cycle and alignment specifications include a percentage of the CLKFX output period. For example, this data sheet specifies a maximum CLKFX jitter of ±(1% of CLKFX period + 200 ps). Assuming that the CLKFX output frequency is 100 MHz, the equivalent CLKFX period is 10 ns, and 1% of 10 ns is 0.1 ns or 100 ps. Accordingly, the maximum jitter is ±(100 ps + 200 ps) = ±300 ps.

Table 57: Switching Characteristics for the Digital Frequency Synthesizer DFS (DCM\_CLKGEN)<sup>(1)</sup>

Symbol	Description	Speed Grade								Units
		-3		-3N		-2		-1L		
		Min	Max	Min	Max	Min	Max	Min	Max	
<b>Output Frequency Ranges (DCM_CLKGEN)</b>										
CLKOUT_FREQ_FX	Frequency for the CLKFX and CLKFX180 outputs	5	375	5	375	5	333	5	200	MHz
CLKOUT_FREQ_FXDV	Frequency for the CLKFXDV output	0.15625	187.5	0.15625	187.5	0.15625	166.5	0.15625	100	MHz
<b>Output Clock Jitter<sup>(2)(3)</sup></b>										
CLKOUT_PER_JITT_FX	Period jitter at the CLKFX and CLKFX180 outputs.	Typical = $\pm[0.2\%$ of CLKFX period + 100]								ps
CLKOUT_PER_JITT_FXDV	Period jitter at the CLKFXDV output.	Typical = $\pm[0.2\%$ of CLKFX period + 100]								ps
CLKFX_FREEZE_VAR	CLKFX period change in free running oscillator mode at the same temperature. FCLKFX > 50 MHz	Maximum = $\pm 3\%$ of CLKFX period								ps
	CLKFX period change in free running oscillator mode at the same temperature. FCLKFX < 50 MHz	Maximum = $\pm 5\%$ of CLKFX period								ps
CLKFX_FREEZE_TEMP_SLOPE	CLKFX period will change in free_oscillator mode over temperature. Add to CLKFX_FREEZE_VAR to determine total CLKFX period change. Percentage change for CLKFX period over 1°C.	Maximum = 0.1								%/°C
<b>Duty Cycle<sup>(4)(5)</sup></b>										
CLKOUT_DUTY_CYCLE_FX	Duty cycle precision for the CLKFX and CLKFX180 outputs, including the BUFGMUX and clock tree duty-cycle distortion	Maximum = $\pm[1\%$ of CLKFX period + 350]								ps
CLKOUT_DUTY_CYCLE_FXDV	Duty cycle precision for the CLKFXDV outputs, including the BUFGMUX and clock tree duty-cycle distortion	Maximum = $\pm[1\%$ of CLKFX period + 350]								ps
<b>Lock Time</b>										
LOCK_FX <sup>(2)</sup>	The time from deassertion at the DCM's Reset input to the rising transition at its LOCKED output. The DFS asserts LOCKED when the CLKFX, CLKFX180, and CLKFXDV signals are valid. Lock time requires CLKFX_DIVIDE < F <sub>IN</sub> /(0.50 MHz) when: F <sub>CLKIN</sub> < 50 MHz	–	50	–	50	–	50	–	50	ms
	when: F <sub>CLKIN</sub> > 50 MHz	–	5	–	5	–	5	–	5	ms

Table 68: Global Clock Input to Output Delay With DCM and PLL in System-Synchronous Mode

Symbol	Description	Device	Speed Grade				Units
			-3	-3N	-2	-1L	
LVCMOS25 Global Clock Input to Output Delay using Output Flip-Flop, 12mA, Fast Slew Rate, with DCM in System-Synchronous Mode and PLL in DCM2PLL Mode.							
T <sub>ICKOFDCM_PLL</sub>	Global Clock and OUTFF with DCM and PLL	XC6SLX4	4.78	N/A	6.32	7.09	ns
		XC6SLX9	4.78	5.24	6.32	7.09	ns
		XC6SLX16	4.70	5.12	5.94	6.63	ns
		XC6SLX25	4.70	5.09	5.92	7.30	ns
		XC6SLX25T	4.70	5.09	5.92	N/A	ns
		XC6SLX45	4.63	4.98	5.83	7.26	ns
		XC6SLX45T	4.63	4.98	5.83	N/A	ns
		XC6SLX75	4.68	5.04	5.88	6.90	ns
		XC6SLX75T	4.68	5.04	5.88	N/A	ns
		XC6SLX100	4.72	5.07	5.92	7.77	ns
		XC6SLX100T	4.76	5.07	5.92	N/A	ns
		XC6SLX150	4.44	4.73	5.31	6.96	ns
		XC6SLX150T	4.44	4.73	5.31	N/A	ns
		XA6SLX4	5.07	N/A	6.18	N/A	ns
		XA6SLX9	5.07	N/A	6.18	N/A	ns
		XA6SLX16	5.22	N/A	5.77	N/A	ns
		XA6SLX25	5.01	N/A	5.80	N/A	ns
		XA6SLX25T	5.01	N/A	5.90	N/A	ns
		XA6SLX45	4.93	N/A	5.67	N/A	ns
		XA6SLX45T	4.93	N/A	5.67	N/A	ns
		XA6SLX75	4.94	N/A	5.70	N/A	ns
		XA6SLX75T	4.94	N/A	5.70	N/A	ns
		XA6SLX100	N/A	N/A	5.77	N/A	ns
		XQ6SLX75	N/A	N/A	5.70	6.90	ns
XQ6SLX75T	4.94	N/A	5.70	N/A	ns		
XQ6SLX150	N/A	N/A	5.31	6.96	ns		
XQ6SLX150T	5.02	N/A	5.31	N/A	ns		

**Notes:**

1. Listed above are representative values where one global clock input drives one vertical clock line in each accessible column, and where all accessible IOB and CLB flip-flops are clocked by the global clock net.
2. DCM and PLL output jitter are already included in the timing calculation.

Table 69: Global Clock Input to Output Delay With DCM and PLL in Source-Synchronous Mode

Symbol	Description	Device	Speed Grade				Units
			-3	-3N	-2	-1L	
LVCMOS25 Global Clock Input to Output Delay using Output Flip-Flop, 12mA, Fast Slew Rate, with DCM in Source-Synchronous Mode and PLL in DCM2PLL Mode.							
T <sub>ICKOFDCM0_PLL</sub>	Global Clock and OUTFF with DCM and PLL	XC6SLX4	5.58	N/A	7.42	8.54	ns
		XC6SLX9	5.58	6.19	7.42	8.54	ns
		XC6SLX16	5.50	6.06	7.05	8.24	ns
		XC6SLX25	5.57	6.04	7.02	8.33	ns
		XC6SLX25T	5.57	6.04	7.02	N/A	ns
		XC6SLX45	5.53	5.97	6.96	8.32	ns
		XC6SLX45T	5.53	5.97	6.96	N/A	ns
		XC6SLX75	5.55	6.00	6.99	8.54	ns
		XC6SLX75T	5.55	6.00	6.99	N/A	ns
		XC6SLX100	5.58	6.03	7.02	9.11	ns
		XC6SLX100T	5.62	6.03	7.02	N/A	ns
		XC6SLX150	5.32	5.70	6.41	8.26	ns
		XC6SLX150T	5.32	5.70	6.41	N/A	ns
		XA6SLX4	5.87	N/A	7.28	N/A	ns
		XA6SLX9	5.87	N/A	7.28	N/A	ns
		XA6SLX16	6.02	N/A	6.87	N/A	ns
		XA6SLX25	5.88	N/A	6.90	N/A	ns
		XA6SLX25T	5.88	N/A	7.00	N/A	ns
		XA6SLX45	5.82	N/A	6.81	N/A	ns
		XA6SLX45T	5.82	N/A	6.81	N/A	ns
		XA6SLX75	5.81	N/A	6.80	N/A	ns
		XA6SLX75T	5.81	N/A	6.80	N/A	ns
		XA6SLX100	N/A	N/A	6.88	N/A	ns
		XQ6SLX75	N/A	N/A	6.80	8.54	ns
XQ6SLX75T	5.81	N/A	6.80	N/A	ns		
XQ6SLX150	N/A	N/A	6.41	8.26	ns		
XQ6SLX150T	5.90	N/A	6.41	N/A	ns		

**Notes:**

1. Listed above are representative values where one global clock input drives one vertical clock line in each accessible column, and where all accessible IOB and CLB flip-flops are clocked by the global clock net.
2. DCM and PLL output jitter are already included in the timing calculation.

Table 79: Package Skew (Cont'd)

Symbol	Description	Device	Package <sup>(2)</sup>	Value	Units
T <sub>PKGSKEW</sub>	Package Skew <sup>(1)</sup>	LX45	CSG324	70	ps
			CS(G)484	99	ps
			FG(G)484	109	ps
			FG(G)676	138	ps
		LX45T	CSG324	75	ps
			CS(G)484	100	ps
			FG(G)484	95	ps
		LX75	CS(G)484	101	ps
			FG(G)484	107	ps
			FG(G)676	161	ps
			LX75T	CS(G)484	107
		FG(G)484		110	ps
		FG(G)676		134	ps
		LX100	CS(G)484	95	ps
			FG(G)484	155	ps
			FG(G)676	144	ps
		LX100T	CS(G)484	88	ps
			FG(G)484	111	ps
			FG(G)676	147	ps
			FG(G)900	134	ps
		LX150	CS(G)484	84	ps
			FG(G)484	103	ps
			FG(G)676	115	ps
			FG(G)900	121	ps
LX150T	CS(G)484	83	ps		
	FG(G)484	88	ps		
	FG(G)676	141	ps		
	FG(G)900	120	ps		

Notes:

1. These values represent the worst-case skew between any two SelectIO resources in the package: shortest delay to longest delay from Pad to Ball.
2. Some of the devices are available in both Pb and Pb-free (additional G) packages as standard ordering options. See [DS160: Spartan-6 Family Overview](#) for more information.

Table 80: Sample Window

Symbol	Description	Device <sup>(1)</sup>	Speed Grade				Units
			-3	-3N	-2	-1L	
T <sub>SAMP</sub>	Sampling Error at Receiver Pins <sup>(2)</sup>	All	510	510	530	740	ps
T <sub>SAMP_BUFIO2</sub>	Sampling Error at Receiver Pins using BUFIO2 <sup>(3)</sup>	All	430	430	450	590	ps

Notes:

1. LXT devices are not available with a -1L speed grade.
2. This parameter indicates the total sampling error of Spartan-6 FPGA DDR input registers, measured across voltage, temperature, and process. The characterization methodology uses the DCM to capture the DDR input registers' edges of operation. These measurements include:
  - CLK0 DCM jitter
  - DCM accuracy (phase offset)
  - DCM phase shift resolution
 These measurements do not include package or clock tree skew.
3. This parameter indicates the total sampling error of Spartan-6 FPGA DDR input registers, measured across voltage, temperature, and process. The characterization methodology uses the BUFIO2 clock network and IODELAY2 to capture the DDR input registers' edges of operation. These measurements do not include package or clock tree skew.

Table 81: Source-Synchronous Pin-to-Pin Setup/Hold and Clock-to-Out Using BUFIO2 (Cont'd)

Symbol	Description	Device	Speed Grade				Units
			-3	-3N	-2	-1L	
<b>Pin-to-Pin Clock-to-Out Using BUFIO2</b>							
T <sub>ICKOFCS</sub>	OFF clock-to-out using BUFIO2 clock	XC6SLX4	5.51	N/A	6.95	8.45	ns
		XC6SLX9	5.51	5.89	6.95	8.45	ns
		XC6SLX16	5.31	5.70	6.67	8.21	ns
		XC6SLX25	5.53	6.00	7.02	8.72	ns
		XC6SLX25T	5.53	6.00	7.02	N/A	ns
		XC6SLX45	5.76	6.18	7.22	8.77	ns
		XC6SLX45T	5.76	6.18	7.22	N/A	ns
		XC6SLX75	5.94	6.46	7.57	9.72	ns
		XC6SLX75T	5.94	6.46	7.57	N/A	ns
		XC6SLX100	6.09	6.53	7.60	9.66	ns
		XC6SLX100T	6.09	6.53	7.60	N/A	ns
		XC6SLX150	6.29	6.69	7.81	9.94	ns
		XC6SLX150T	6.29	6.69	7.81	N/A	ns
		XA6SLX4	5.83	N/A	6.95	N/A	ns
		XA6SLX9	5.83	N/A	6.95	N/A	ns
		XA6SLX16	5.65	N/A	6.68	N/A	ns
		XA6SLX25	5.85	N/A	7.03	N/A	ns
		XA6SLX25T	5.85	N/A	7.03	N/A	ns
		XA6SLX45	6.07	N/A	7.25	N/A	ns
		XA6SLX45T	6.07	N/A	7.25	N/A	ns
		XA6SLX75	6.26	N/A	7.57	N/A	ns
		XA6SLX75T	6.26	N/A	7.57	N/A	ns
		XA6SLX100	N/A	N/A	7.48	N/A	ns
		XQ6SLX75	N/A	N/A	7.57	9.72	ns
		XQ6SLX75T	6.26	N/A	7.57	N/A	ns
		XQ6SLX150	N/A	N/A	7.81	9.94	ns
XQ6SLX150T	6.62	N/A	7.81	N/A	ns		

Date	Version	Description of Revisions
06/14/10	1.5	<p>In <a href="#">Table 2</a>, added note 5 and added temperature range to <math>V_{FS}</math> and <math>R_{FUSE}</math>. Removed speed grade delineation, revised <math>I_{RPD}</math> description, and updated note 2 in <a href="#">Table 4</a>. Added note 2 to <a href="#">Table 7</a>. Added DIFF_MOBILE_DDR to <a href="#">Table 8</a> and <a href="#">Table 10</a>. Added note 4 to <a href="#">Table 15</a>. Changed minimum <math>DV_{PPIN}</math> in <a href="#">Table 16</a>. Updated <math>F_{GTPDRPCLK}</math> in <a href="#">Table 19</a>. Increased maximum <math>T_{LLSKEW}</math> in <a href="#">Table 22</a>. Updated descriptions and added data to <a href="#">Table 23</a>. Removed note 1 and added new data to the Networking Applications section in <a href="#">Table 25</a>. Updated <a href="#">Table 26</a> and <a href="#">Table 27</a> to the data in ISE v12.1 software with speed specification v1.08. In <a href="#">Table 28</a>, added DIFF_MOBILE_DDR and updated -4 speed grade data. Updated the maximum I/O pairs per bank in <a href="#">Table 33</a>. Updated note 2 on <a href="#">Table 39</a>. Revised the <math>F_{MAX}</math> in <a href="#">Table 44</a>. In <a href="#">Table 47</a>, updated description for <math>T_{SMCKCSO}</math>, revised values for <math>T_{POR}</math> and added Min value, added <math>T_{BPIICCK}</math> and <math>T_{SPIICCK}</math>. Also in <a href="#">Table 47</a>, added device dependencies to <math>F_{SMCCK}</math> and <math>F_{RBCKK}</math>. Updated and added data to <a href="#">Table 63</a> through <a href="#">Table 78</a>, and <a href="#">Table 81</a>. In <a href="#">Table 79</a>, added data on the XC6SLX45-FG(G)676 and revised the XC6SLX45T and XC6SLX150T values.</p> <p>The following changes to this specification are addressed in the product change notice <a href="#">XCN10024</a>, <i>MCB Performance and JTAG Revision Code for Spartan-6 LX16 and LX45 FPGAs</i>. In <a href="#">Table 2</a>, revised the <math>V_{CCINT}</math> to add the memory controller block extended performance specifications. In <a href="#">Table 25</a>, changed the standard specifications and added extended performance specifications for the memory controller block and note 2. Added note 4 and updated values in <a href="#">Table 34</a>.</p>
06/24/10	1.6	<p>Production release of XC6SLX45T (-2 and -3 speed grades), XC6SLX16 and XC6SLX45 (-3 speed grade) devices which includes changes to <a href="#">Table 26</a> and <a href="#">Table 27</a> (ISE v12.1 software with speed specification v1.08).</p> <p>Added the -3N speed grade, which designates Spartan-6 devices that do not support MCB functionality. This includes changes to <a href="#">Table 2</a> (note 2), <a href="#">Table 25</a> (note 4), and <a href="#">Switching Characteristics</a> (<a href="#">Table 26</a>).</p> <p>Updated <a href="#">Simultaneously Switching Outputs</a> discussion. Added -3 speed grade values for <math>T_{TAP}</math> and <math>F_{MINCAL}</math> values in <a href="#">Table 39</a>. In <a href="#">Table 40</a>, updated <math>T_{RPW}</math> (-2 and -3 speed grade) values and <math>F_{TOG}</math> (-3 speed grade) values. In <a href="#">Table 48</a>, updated <math>T_{GIO}</math> (-2 and -3 speed grade) values. Updated -3 values in spread spectrum section of <a href="#">Table 57</a>.</p>
07/16/10	1.7	<p>Production release of specific devices listed in <a href="#">Table 26</a> and <a href="#">Table 27</a> using ISE v12.2 software with speed specification v1.11. Added note 4 advising designers of the patch which contains v1.11. Also updated the -1L speed specification to v1.04. Updated numerous -4 and -1L values. Added -4 <math>T_{TAP}</math> values and <math>F_{MINCAL}</math> to <a href="#">Table 39</a>. Revised <math>T_{CINCK}/T_{CKCIN}</math> in <a href="#">Table 40</a>. In <a href="#">Table 41</a>, revised <math>T_{SHCKO}</math>. In <a href="#">Table 42</a>, revised <math>T_{REG}</math>. Added new -1L values to <a href="#">Table 47</a>. Added and updated values in <a href="#">Table 79</a>.</p>
07/26/10	1.8	<p>Production release of XC6SLX25, XC6SLX25T, XC6SLX100 and XC6SLX100T in the specific speed grades listed in <a href="#">Table 26</a> and <a href="#">Table 27</a> using ISE v12.2 software with speed specification v1.11. Added note 7 to <a href="#">Table 2</a> and moved <math>V_{FS}</math> and <math>R_{FUSE}</math> to a new <a href="#">Table 3</a>. Added <math>I_{HS}</math> and note 4 to <a href="#">Table 4</a>. Added note 1 to <a href="#">Table 28</a>. Added and updated SSO limits per <math>V_{CC0}/GND</math> pairs in <a href="#">Table 34</a>. Added note 3 to <a href="#">Table 47</a>. In <a href="#">Table 54</a>, removed -1L specifications for CLKOUT_PER_JITT_DV1/2 and revised CLKIN_CLKFB_PHASE and CLKOUT_PHASE_DLL values. Updated note 3 in both <a href="#">Table 56</a> and <a href="#">Table 57</a>.</p>
08/23/10	1.9	<p>Updated values for <math>F_{GTPRANGE1}</math>, <math>F_{GTPRANGE2}</math>, and <math>F_{GPLLMIN}</math> in <a href="#">Table 18</a>. Revised -3 and -4 values in <a href="#">Table 21</a>. Removed the -1L speed grade readback support restriction and note 3 in <a href="#">Table 47</a>.</p>
11/05/10	1.10	<p>Production release of XC6SLX4 and XC6SLX9 in the specific speed grades listed in <a href="#">Table 26</a> and <a href="#">Table 27</a> using ISE v12.3 software with speed specification v1.12 for the -2 speed grade available in the 12.3 <i>Speed Files Patch</i>. Added note 3 advising designers of the patch which contains v1.12.</p> <p>In <a href="#">Table 2</a>, added note 4. In <a href="#">Table 4</a>, added note 2. In <a href="#">Table 10</a>, added notes 2 and 3. In <a href="#">Table 44</a>, added note 2. In <a href="#">Table 47</a>, updated symbol for <math>T_{SMWCKK}/T_{SMCKKW}</math>, changed -1L values for <math>T_{USERCCLKH}</math> and <math>T_{USERCCLKL}</math>, and added and revised the modes for <math>F_{MCKK}</math> and <math>F_{SMCKK}</math>. In <a href="#">Table 53</a>, redefined and expanded description for CLKIN_FREQ_DLL and rewrote note 3. Updated title of <a href="#">Table 58</a>. Also in <a href="#">Table 78</a>, revised <math>T_{DCD\_CLK}</math> for XC6SLX150 and XC6SLX150T. Changed description of <math>T_{PSFD}/T_{PHFD}</math> in <a href="#">Table 71</a>.</p> <p>For the -1L speed grade, updated data sheet to ISE 12.3 software with speed specification v1.05 which revised the values in the following tables: <a href="#">Table 25</a>, <a href="#">Table 28</a>, <a href="#">Table 35</a>, <a href="#">Table 36</a>, <a href="#">Table 37</a>, <a href="#">Table 40</a> through <a href="#">Table 43</a>, <a href="#">Table 48</a> through <a href="#">Table 56</a>, <a href="#">Table 62</a> through <a href="#">Table 78</a>, <a href="#">Table 80</a>, and <a href="#">Table 81</a>. Updated <a href="#">Notice of Disclaimer</a>.</p>